



**THE DATASHEET OF
RB521S30YL**





RB521S30

200 mA low Vf MEGA Schottky barrier rectifier

7 April 2021

Product data sheet

1. General description

Planar Maximum Efficiency General Application (MEGA) Schottky barrier rectifier with an integrated guard ring for stress protection, encapsulated in a SOD523 (SC-79) ultra small and flat lead Surface-Mounted Device (SMD) plastic package.

2. Features and benefits

- Average forward current: $I_{F(AV)} \leq 0.2$ A
- Reverse voltage: $V_R \leq 30$ V
- Low reverse current: $I_R \leq 30$ μ A
- AEC-Q101 qualified
- Ultra small and flat lead SMD plastic package

3. Applications

- Low current rectification
- High efficiency DC-to-DC conversion
- Switch Mode Power Supply (SMPS)
- Reverse polarity protection
- Low power consumption applications

4. Quick reference data

Table 1. Quick reference data



Symbol	Parameter	Conditions	Min	Typ	Max	Unit
$I_{F(AV)}$	average forward current	$\delta = 0.5$; $f = 20$ kHz; square wave; $T_{amb} \leq 120$ °C [1]	-	-	0.2	A
		$\delta = 0.5$; $f = 20$ kHz; square wave; $T_{sp} \leq 140$ °C	-	-	0.2	A
I_R	reverse current	$V_R = 10$ V	-	2.5	30	μ A
V_R	reverse voltage	$T_j = 25$ °C	-	-	30	V
V_F	forward voltage	$I_F = 200$ mA [2]	-	420	500	mV

[1] Device mounted on an FR4 PCB, single-sided copper, tin-plated, mounting pad for cathode 1 cm².

[2] Pulsed test: $t_p \leq 300$ μ s; $\delta \leq 0.02$

5. Pinning information

Table 2. Pinning information

Pin	Symbol	Description	Simplified outline	Graphic symbol
1	K	cathode ^[1]	 <p>SC-79 (SOD523)</p>	 <p>sym001</p>
2	A	anode		

[1] The marking bar indicates the cathode.

6. Ordering information

Table 3. Ordering information

Type number	Package		
	Name	Description	Version
RB521S30	SC-79	plastic, surface-mounted package; 2 leads; 1.2 mm x 0.8 mm x 0.6 mm body	SOD523

7. Marking

Table 4. Marking codes

Type number	Marking code
RB521S30	ZB

8. Limiting values

Table 5. Limiting values

In accordance with the Absolute Maximum Rating System (IEC 60134).

Symbol	Parameter	Conditions		Min	Max	Unit
V_R	reverse voltage	$T_j = 25\text{ °C}$		-	30	V
$I_{F(AV)}$	average forward current	$\delta = 0.5$; $f = 20\text{ kHz}$; square wave; $T_{amb} \leq 120\text{ °C}$	[1]	-	0.2	A
		$\delta = 0.5$; $f = 20\text{ kHz}$; square wave; $T_{sp} \leq 140\text{ °C}$		-	0.2	A
I_{FSM}	non-repetitive peak forward current	$t_p = 8.3\text{ ms}$; half sine wave; JEDEC method; $T_{j(init)} = 25\text{ °C}$	[2]	-	1	A
P_{tot}	total power dissipation	$T_{amb} \leq 25\text{ °C}$	[3] [4]	-	275	mW
			[1] [4]	-	420	mW
			[5] [4]	-	500	mW
T_j	junction temperature			-	150	°C
T_{amb}	ambient temperature			-55	150	°C
T_{stg}	storage temperature			-65	150	°C

[1] Device mounted on an FR4 PCB, single-sided copper, tin-plated, mounting pad for cathode 1 cm^2 .

[2] $T_j = 25\text{ °C}$ Prior to surge

[3] Device mounted on an FR4 PCB, single-sided copper, tin-plated and standard footprint.

[4] Reflow soldering is the only recommended soldering method.

[5] Device mounted on a ceramic PCB, Al_2O_3 , standard footprint.

9. Thermal characteristics

Table 6. Thermal characteristics

Symbol	Parameter	Conditions		Min	Typ	Max	Unit
$R_{th(j-a)}$	thermal resistance from junction to ambient	in free air	[1] [2] [3]	-	-	455	K/W
			[1] [4] [3]	-	-	300	K/W
			[1] [5] [3]	-	-	250	K/W
$R_{th(j-sp)}$	thermal resistance from junction to solder point		[6]	-	-	90	K/W

[1] For Schottky barrier diodes thermal runaway has to be considered, as in some applications the reverse power losses P_R are a significant part of the total power losses.

[2] Device mounted on an FR4 PCB, single-sided copper, tin-plated and standard footprint.

[3] Reflow soldering is the only recommended soldering method.

[4] Device mounted on an FR4 PCB, single-sided copper, tin-plated, mounting pad for cathode 1 cm^2 .

[5] Device mounted on a ceramic PCB, Al_2O_3 , standard footprint.

[6] Soldering point of cathode tab.

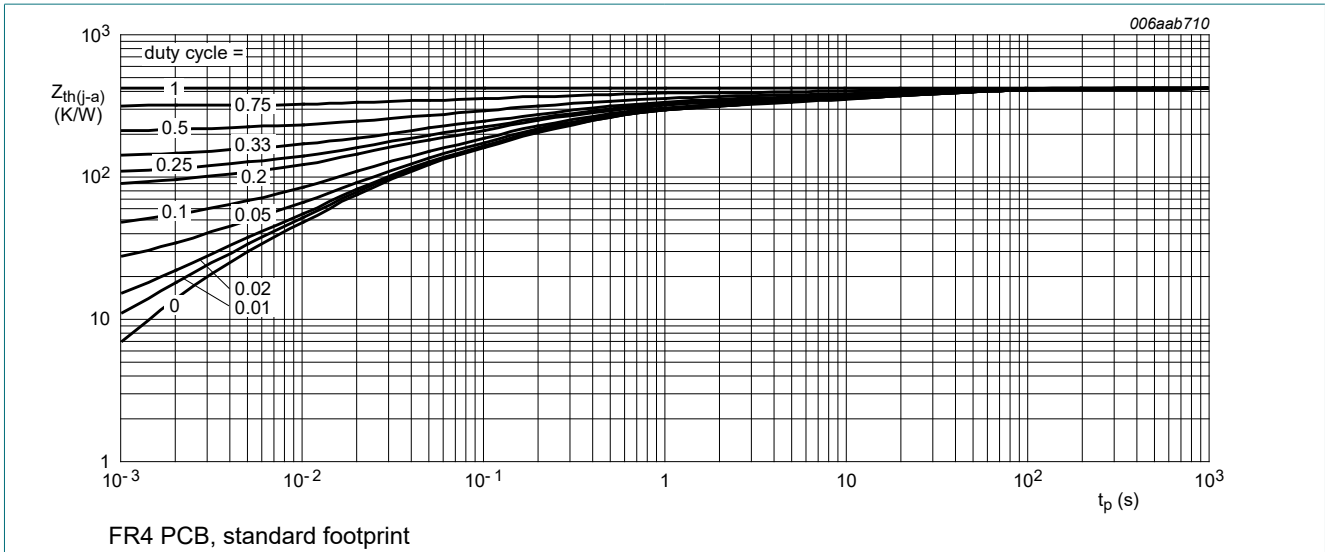


Fig. 1. Transient thermal impedance from junction to ambient as a function of pulse duration; typical values

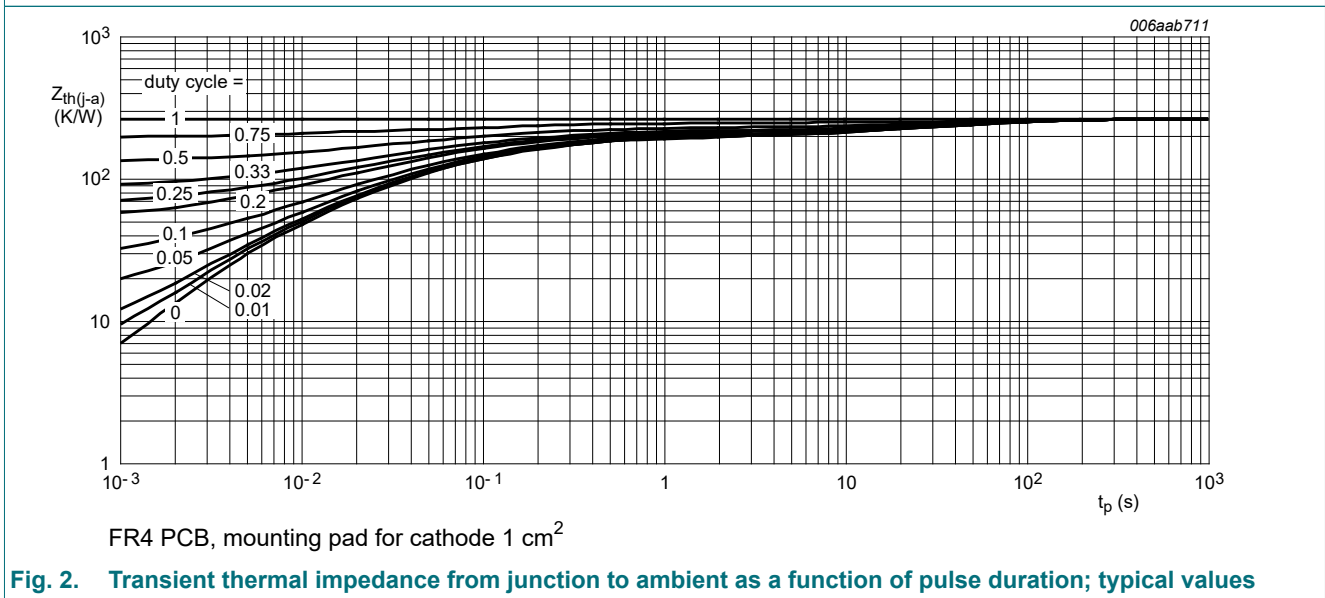


Fig. 2. Transient thermal impedance from junction to ambient as a function of pulse duration; typical values

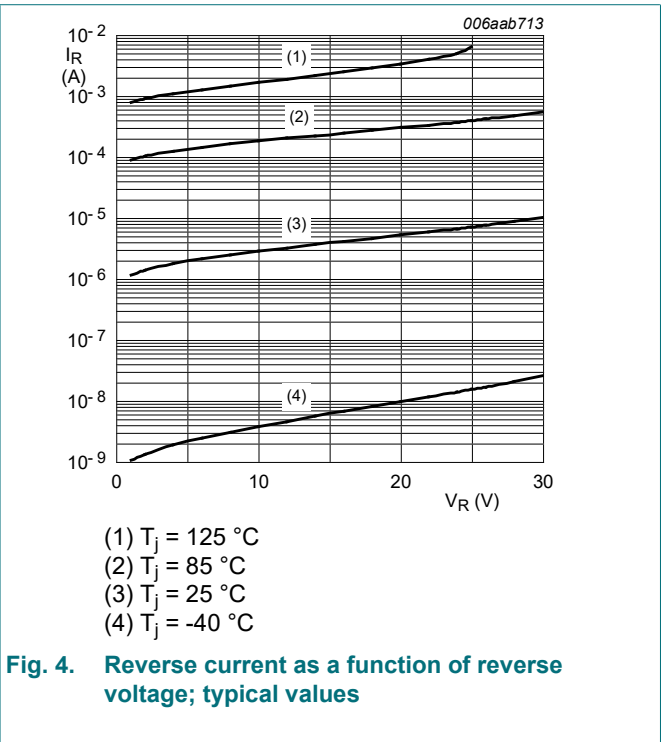
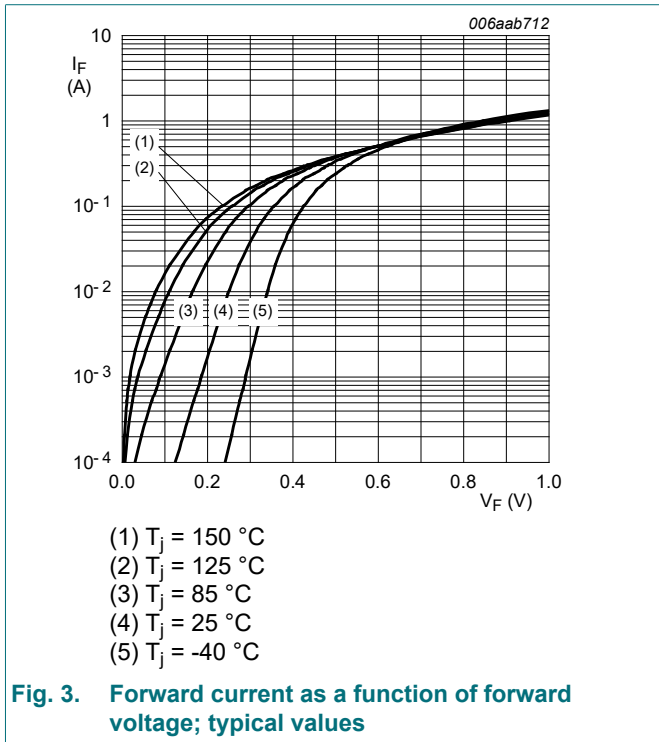
10. Characteristics

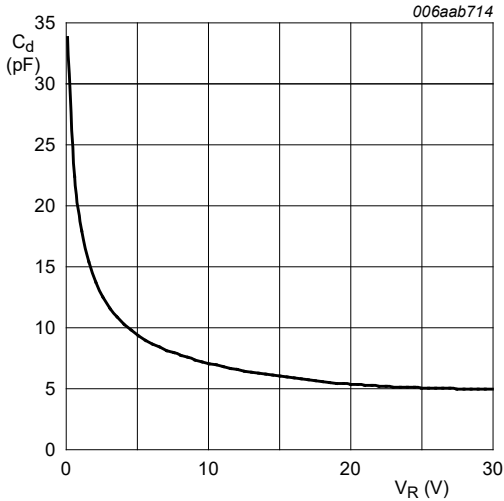
Table 7. Characteristics

$T_{amb} = 25\text{ °C}$ unless otherwise specified.

Symbol	Parameter	Conditions		Min	Typ	Max	Unit
V_F	forward voltage	$I_F = 0.1\text{ mA}$	[1]	-	130	190	mV
		$I_F = 1\text{ mA}$	[1]	-	190	250	mV
		$I_F = 10\text{ mA}$	[1]	-	255	300	mV
		$I_F = 100\text{ mA}$	[1]	-	355	410	mV
		$I_F = 200\text{ mA}$	[1]	-	420	500	mV
I_R	reverse current	$V_R = 10\text{ V}$		-	2.5	30	μA
C_d	diode capacitance	$V_R = 1\text{ V}; f = 1\text{ MHz}$		-	20	25	pF

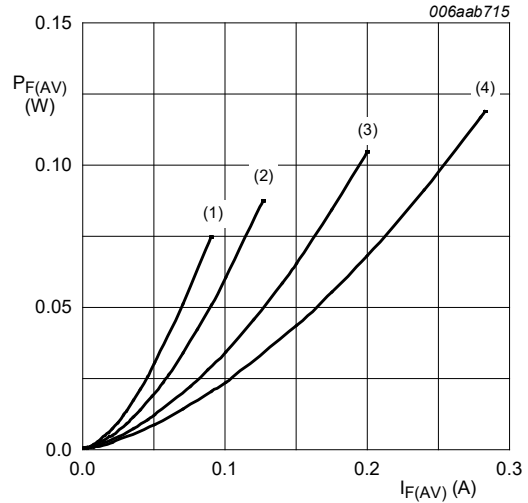
[1] Pulsed test: $t_p \leq 300\text{ }\mu\text{s}; \delta \leq 0.02$





$f = 1 \text{ MHz}; T_{\text{amb}} = 25 \text{ }^\circ\text{C}$

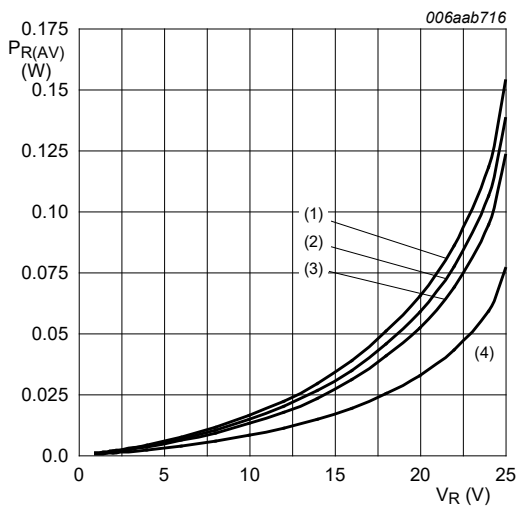
Fig. 5. Diode capacitance as a function of reverse voltage; typical values



$T_j = 150 \text{ }^\circ\text{C}$

- (1) $\delta = 0.1$
- (2) $\delta = 0.2$
- (3) $\delta = 0.5$
- (4) $\delta = 1$

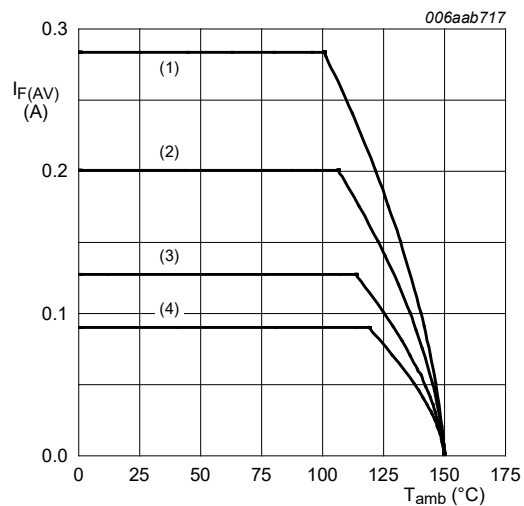
Fig. 6. Average forward power dissipation as a function of average forward current; typical values



$T_j = 125 \text{ }^\circ\text{C}$

- (1) $\delta = 1$
- (2) $\delta = 0.9$
- (3) $\delta = 0.8$
- (4) $\delta = 0.5$

Fig. 7. Average reverse power dissipation as a function of reverse voltage; typical values



FR4 PCB, standard footprint

$T_j = 150 \text{ }^\circ\text{C}$

- (1) $\delta = 1; \text{DC}$
- (2) $\delta = 0.5; f = 20 \text{ kHz}$
- (3) $\delta = 0.2; f = 20 \text{ kHz}$
- (4) $\delta = 0.1; f = 20 \text{ kHz}$

Fig. 8. Average forward current as a function of ambient temperature; typical values

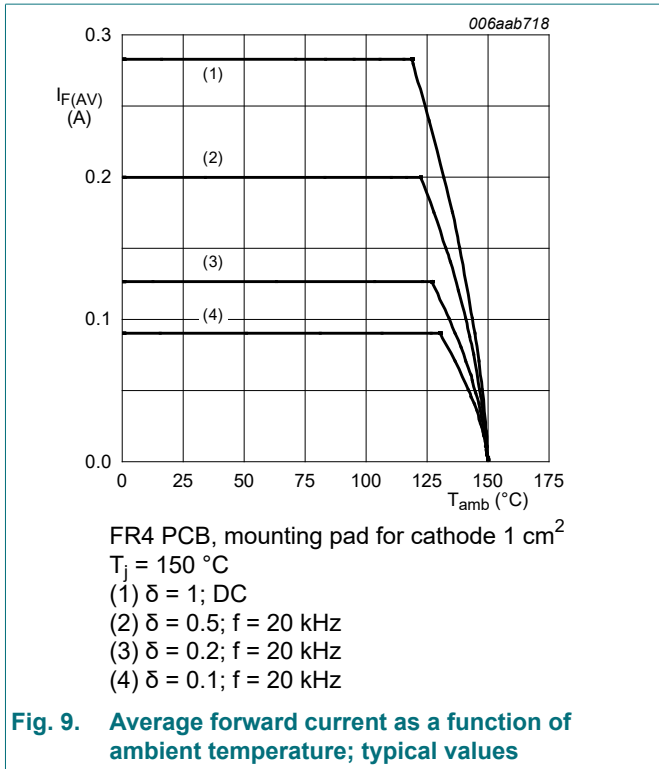


Fig. 9. Average forward current as a function of ambient temperature; typical values

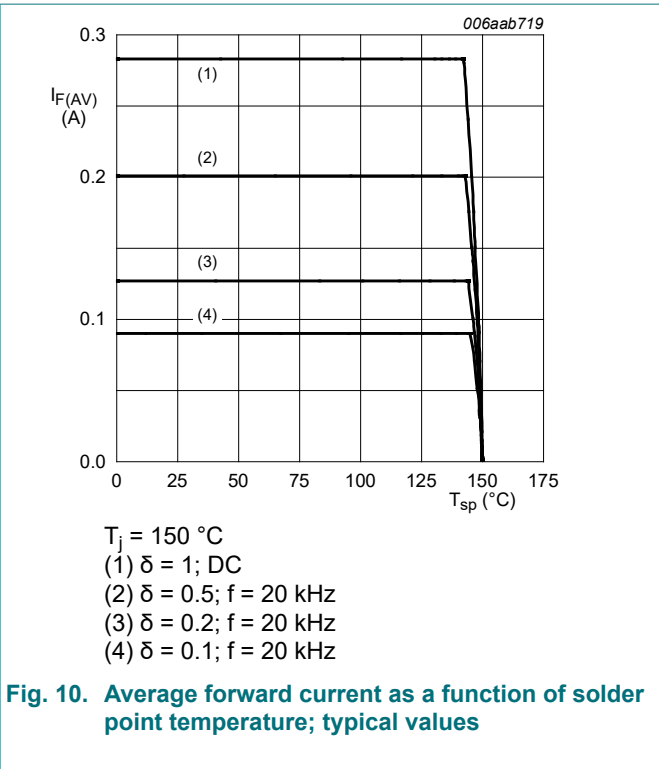


Fig. 10. Average forward current as a function of solder point temperature; typical values

11. Test information

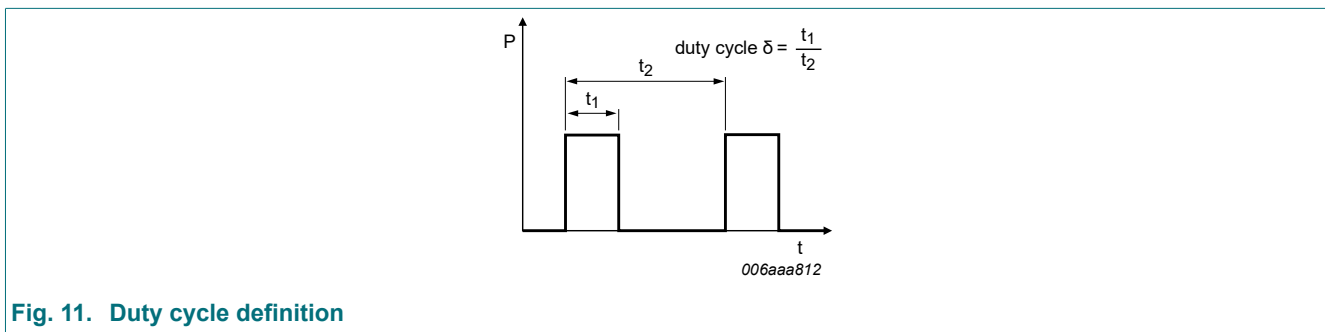


Fig. 11. Duty cycle definition

The current ratings for the typical waveforms are calculated according to the equations: $I_{F(AV)} = I_M \times \delta$ with I_M defined as peak current, $I_{RMS} = I_{F(AV)}$ at DC, and $I_{RMS} = I_M \times \sqrt{\delta}$ with I_{RMS} defined as RMS current.

Quality information

This product has been qualified in accordance with the Automotive Electronics Council (AEC) standard Q101 - *Stress test qualification for discrete semiconductors*, and is suitable for use in automotive applications.

12. Package outline

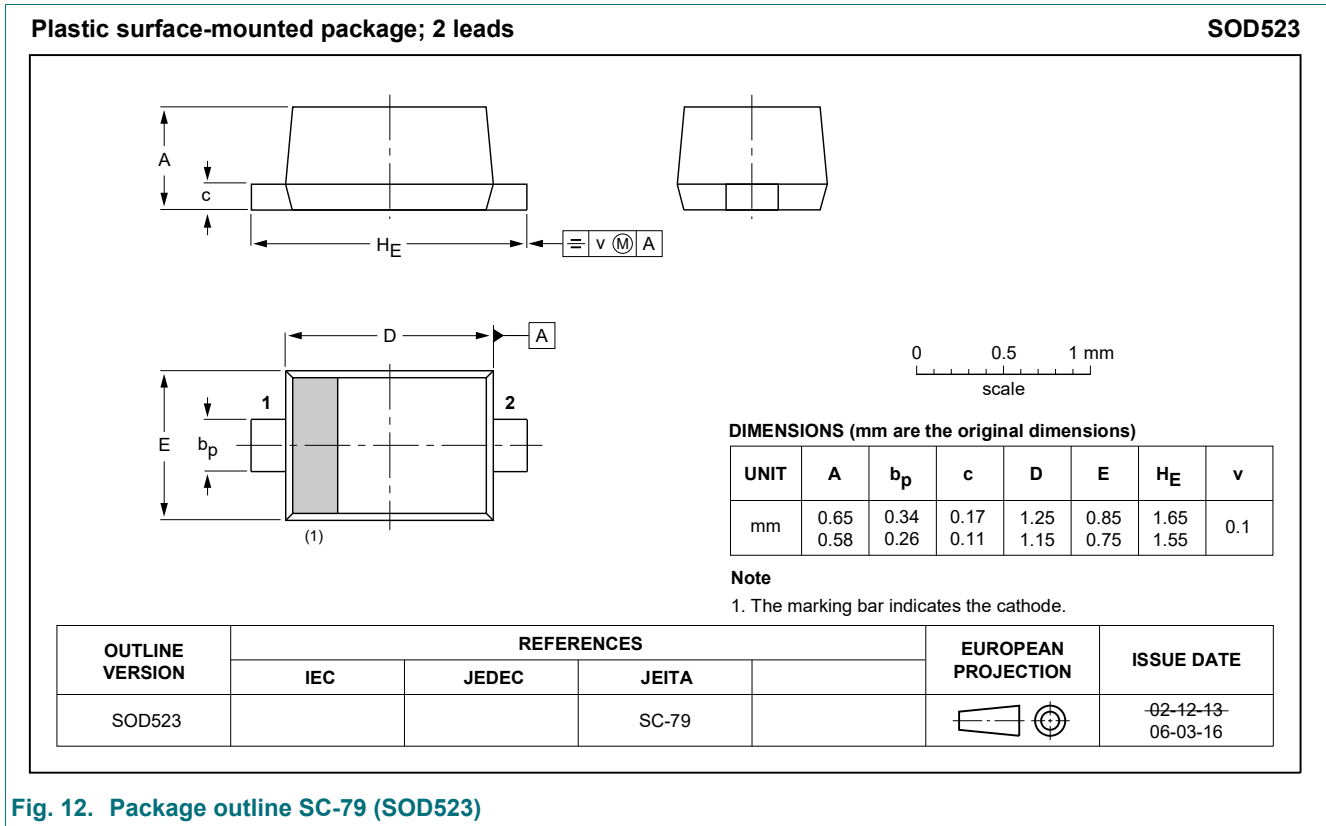


Fig. 12. Package outline SC-79 (SOD523)

13. Soldering

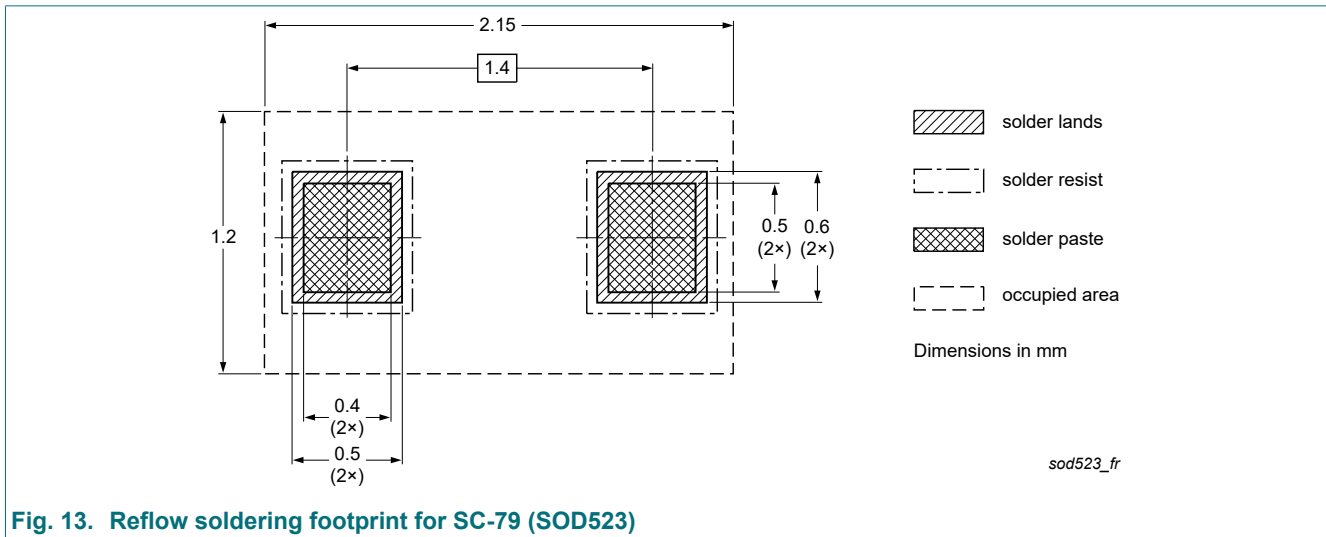


Fig. 13. Reflow soldering footprint for SC-79 (SOD523)

14. Revision history

Table 8. Revision history

Data sheet ID	Release date	Data sheet status	Change notice	Supersedes
RB521S30 v.2	20210407	Product data sheet	-	RB521S30 v.1
Modifications:	<ul style="list-style-type: none">• Test information: Figure 11 removed• Soldering: Figure 14: "Reflow soldering footprint for SOD523" updated• The format of this data sheet has been redesigned to comply with the identity guidelines of Nexperia.• Legal texts have been adapted to the new company name where appropriate.			
RB521S30 v.1	20091006	Product data sheet	-	-

15. Legal information

Data sheet status

Document status [1][2]	Product status [3]	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
Preliminary [short] data sheet	Qualification	This document contains data from the preliminary specification.
Product [short] data sheet	Production	This document contains the product specification.

- [1] Please consult the most recently issued document before initiating or completing a design.
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